SE15FD, SE15FG, SE15FJ

Vishay General Semiconductor

Surface Mount Standard Rectifiers



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PRIMARY CHARACTERISTICS							
I _{F(AV)}	1.5 A						
V _{RRM}	200 V, 400 V, 600 V						
I _{FSM}	30 A						
V_F at I_F = 1.5 A (T_A = 125 °C)	0.86 V						
I _R	5 µA						
T _J max.	175 °C						
Package	DO-219AB (SMF)						
Diode variations	Single die						

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in commercial, industrial, and automotive applications.

FEATURES

- Low profile package
- · Ideal for automated placement
- Oxide planar chip junction
- · Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, J-STD-020, per LF maximum peak of 260 °C
- · Wave and reflow solderable
- AEC-Q101 gualified available Automotive ordering code: base P/NHM3
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

MECHANICAL DATA

Case: DO-219AB (SMF)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - for halogen-free, and RoHS-compliant

Base P/NHM3 - for halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)									
PARAMETER	SE15FJ	UNIT							
Device marking code		BD	BG	BJ					
Maximum repetitive peak reverse voltage	V _{RRM}	200	400	600	V				
Maximum DC forward current	I _{F(AV)} ⁽¹⁾	1.5			A				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}		А						
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175							

Notes

⁽¹⁾ Free air, mounted on recommended PCB, 2 oz. pad area

ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)									
PARAMETER	TEST C	ONDITIONS	SYMBOL	TYP.	MAX.	UNIT			
Instantaneous forward voltage	1 - 1 5 4	T _A = 25 °C	V _F ⁽¹⁾	0.96	1.05	V			
	l _F = 1.5 A	T _A = 125 °C	VF ()	0.86	0.95	v			
Reverse current	Deted	T _A = 25 °C	I _R ⁽²⁾	-	5	μA			
	Rated V _R	T _A = 125 °C	IR (=/	19	50				
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0	0 A, I _{rr} = 0.25 A	t _{rr}	900	-	ns			
Typical junction capacitance	4.0 V, 1 MHz		CJ	10.5	-	pF			

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

Revision: 01-Sep-16

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RoHS

COMPLIANT

HALOGEN FREE





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THERMAL CHARACTERISTICS ($T_A = 25$ °c unless otherwise noted)									
PARAMETER	SYMBOL	SE15FD	SE15FJ	UNIT					
Typical thermal resistance	R _{0JA} ⁽¹⁾		°C/W						
	R _{0JM} ⁽¹⁾			C/W					

Notes

⁽¹⁾ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance R_{0JA} - junction to ambient; R_{0JM} - junction to mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25$ °C unless otherwise noted)									
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE				
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 k Ω	V _C	H3B	> 8 kV				

ORDERING INFORMATION (Example)										
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE						
SE15FJ-M3/H	0.015	Н	3000	7" diameter plastic tape and reel						
SE15FJ-M3/I	0.015	I	10 000	13" diameter plastic tape and reel						
SE15FJHM3/H ⁽¹⁾	0.015	н	3000	7" diameter plastic tape and reel						
SE15FJHM3/I ⁽¹⁾	0.015		10 000	13" diameter plastic tape and reel						

Note

⁽¹⁾ AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

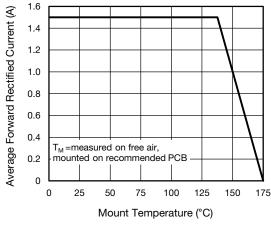
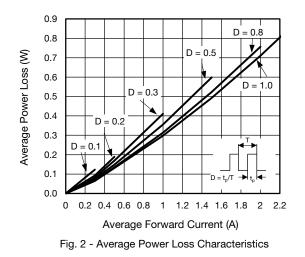


Fig. 1 - Maximum Forward Current Derating Curve



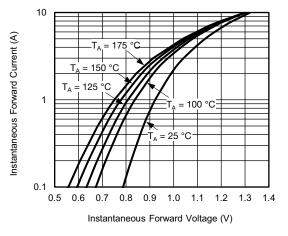


Fig. 3 - Typical Instantaneous Forward Characteristics

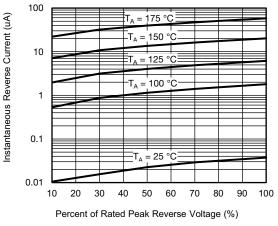
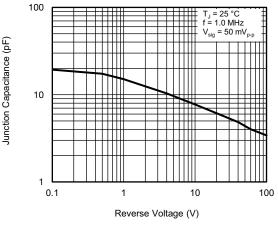
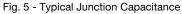


Fig. 4 - Typical Reverse Leakage Characteristics





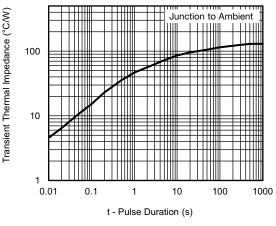


Fig. 6 - Typical Transient Thermal Impedance

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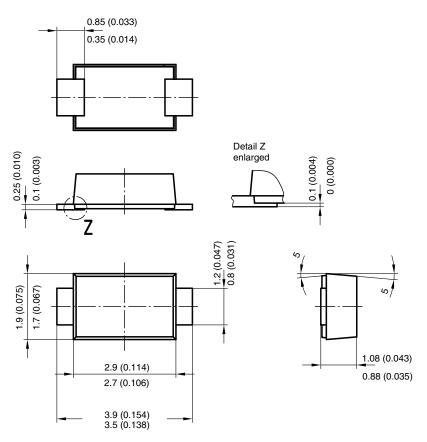
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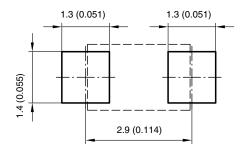


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PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



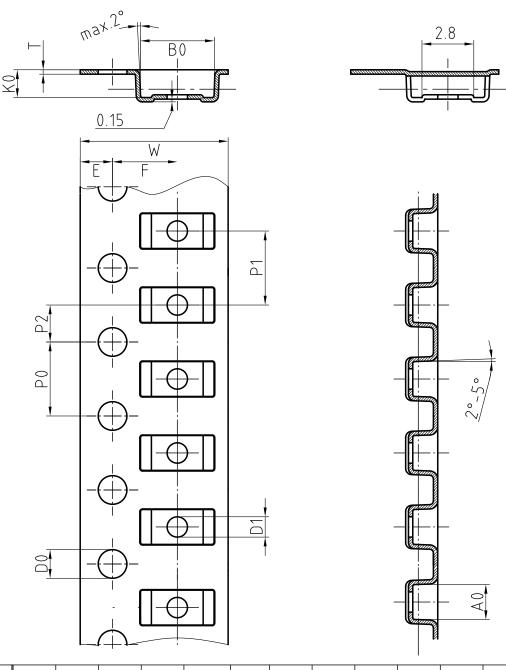
Created - Date: 15. February 2005 Rev. 3 - Date: 13. March 2007 Document no.:S8-V-3915.01-001 (4) 17247



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BLISTERTAPE DIMENSIONS in millimeters: DO-219AB (SMF)



Mat:	Α0	B0	K0	W	Т	Ρ0	P2	P1	D0	D1	E	F
PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

Document-No.: S8-V-3717.02-001 (3)

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